

Data Sheet

Description

The EU2Z is a fast recovery diode of 200 V / 1.0 A. The maximum $t_{\rm rr}$ of 400 ns is realized by optimizing a life-time control.

Features

| • | V _{RM} | 200 V |
|---|------------------|--------|
| • | $I_{F(AV)}$ | 1.0 A |
| | V_F | |
| • | t _{rr1} | 400 ns |

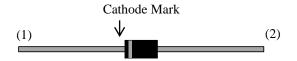
- Bare Leads: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

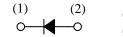
Applications

- Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

Axial (φ 2.7 × 5.0L / φ 0.78)





- (1) Cathode
- (2) Anode

Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

| Parameter | Symbol | Conditions | Rating | Unit |
|------------------------------------|--------------------|----------------------------------------------------|------------|--------|
| Nonrepetitive Peak Reverse Voltage | V _{RSM} | | 250 | V |
| Repetitive Peak Reverse Voltage | V_{RM} | | 200 | V |
| Average Forward Current | I _{F(AV)} | See Figure 2 and Figure 3. | 1.0 | A |
| Surge Forward Current | I_{FSM} | Half cycle sine wave, positive side, 10 ms, 1 shot | 15 | A |
| I ² t Limiting Value | I ² t | $1 \text{ ms} \le t \le 10 \text{ ms}$ | 1.1 | A^2s |
| Junction Temperature | T_{J} | | -40 to 150 | °C |
| Storage Temperature | T_{STG} | | -40 to 150 | °C |

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|------------------------------------------------|----------------------|---------------------------------------------------------------------------------------|------|------|------|------|
| Formand Voltage Dues | V_{F} | $T_J = 25 ^{\circ}\text{C}, I_F = 1.0 \text{A}$ | _ | _ | 1.4 | V |
| Forward Voltage Drop | | $T_J = 100 ^{\circ}\text{C}, I_F = 1.0 \text{A}$ | _ | 0.83 | _ | V |
| Reverse Leakage Current | I_R | $V_R = V_{RM}$ | _ | _ | 10 | μΑ |
| Reverse Leakage Current under High Temperature | $H \cdot I_R$ | $V_R = V_{RM}, T_J = 150 ^{\circ}C$ | _ | | 3 | mA |
| Decrees Decrees Time | $t_{\mathrm{rr}1}$ | $I_F = I_{RP} = 10 \text{ mA},$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$ | _ | _ | 400 | ns |
| Reverse Recovery Time | t _{rr2} | $I_F = 10$ mA, $I_{RP} = 20$ mA, 75% recovery point, $T_J = 25$ °C | — | _ | 180 | ns |
| Thermal Resistance (1) | R _{th(J-L)} | See Figure 1. | _ | _ | 17 | °C/W |

Mechanical Characteristics

| Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------------|------------|------|------|------|------|
| Package Weight | | _ | 0.3 | _ | g |

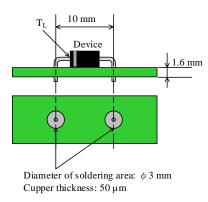
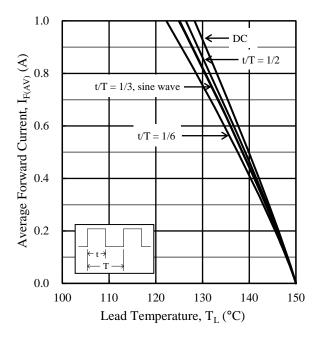
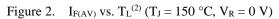


Figure 1. Lead Temperature Measurement Conditions

 $^{^{(1)}}R_{th\,(J-L)}$ is thermal resistance between junction and lead. Lead temperature (T_L) is measured near the root of pin (see Figure 1.

Derating Curves





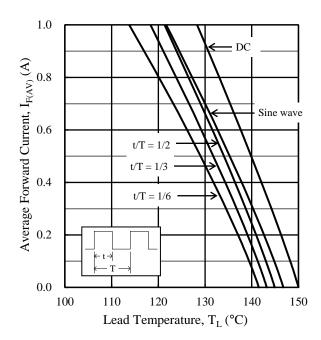


Figure 3. $I_{F(AV)}$ vs. $T_L^{(2)}$ ($T_J = 150$ °C, $V_R = 200$ V)

⁽²⁾ See Figure 1 for the lead temperature measurement conditions.

Characteristic Curves

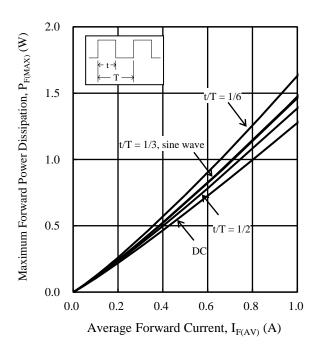


Figure 4. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

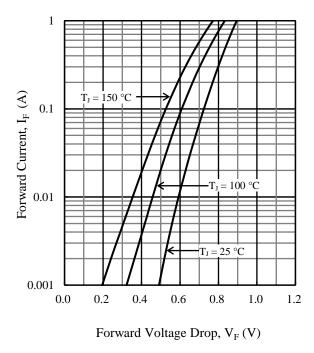


Figure 6. Typical Characteristics: I_F vs. V_F

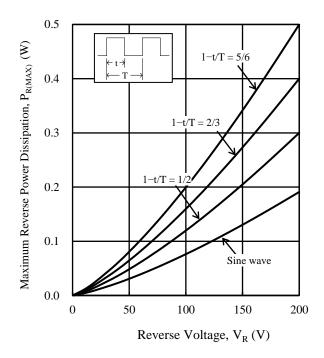


Figure 5. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

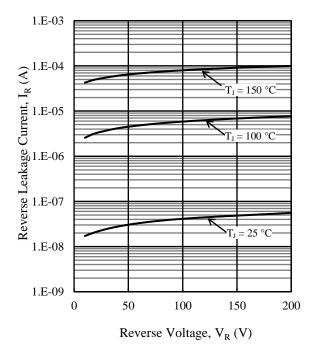


Figure 7. Typical Characteristics: I_R vs. V_R

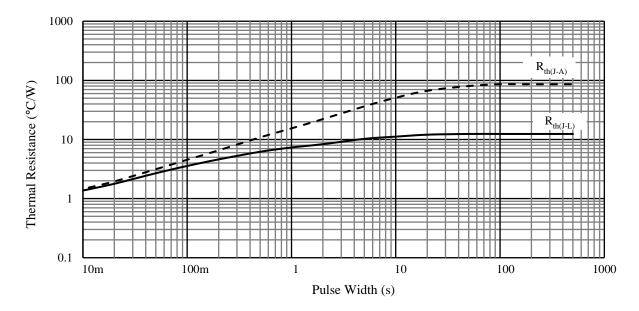
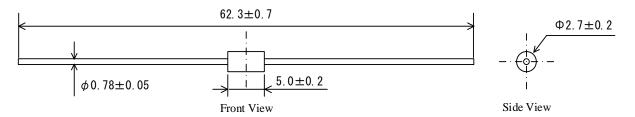


Figure 8. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• Axial $(\phi 2.7 \times 5.0 L / \phi 0.78)$



NOTES:

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- The total length of the product is the dimension when delivered separately and depends on the taping and lead forming specifications.
- The allowance position of body against the center of the total length of the product is 0.5 mm (max.); see Front View.
- The allowance position of lead against the center of body is 0.2 mm (max.); see Side View.
- The burr may exist up to 2 mm from the body of lead root.
- When soldering the products, it is required to minimize the working time within the following limits: Flow: $260 \,^{\circ}\text{C} / 10 \, \text{s}$, 1 time Soldering Iron: $350 \,^{\circ}\text{C} / 3.5 \, \text{s}$, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

Marking Diagram

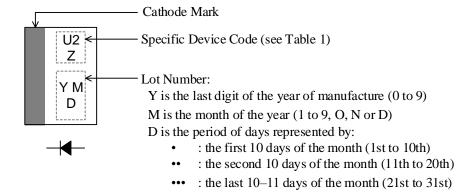


Table 1. Specific Device Code

| Specific Device Code | Part Number |
|----------------------|-------------|
| U2Z | EU2Z |

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